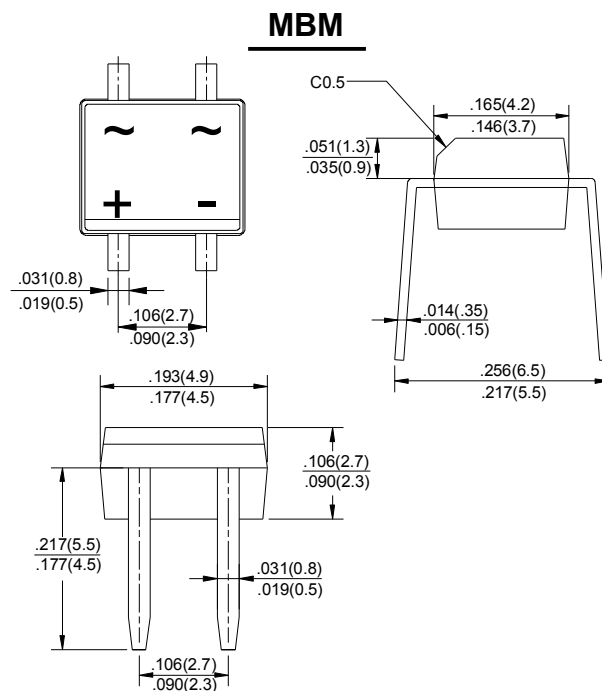


"-G" : RoHS Device

- Rating to 1000V PRV
- Ideal for printed circuit board
- Reliable low cost construction utilizing molded plastic technique results in inexpensive product
- Lead tin plated copper

- Polarity: Symbol molded on body
- Weight: 0.0044 ounces, 0.125 grams
- Mounting position : Any



Dimensions in inches and (millimeters)

For capacitive load, derate current by 20%

CHARACTERISTICS	SYMBOL	MB05M	MB1M	MB2M	MB4M	MB6M	MB8M	MB10M	UNIT
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current (Note 1) @T _A =40 °C	I _(AV)	0.8							A
Peak Forward Surge Current 8.3ms Single Half Sine-Wave Super Imposed on Rated Load(JEDEC Method)	I _{FSM}	30							A
Peak Forward Voltage at 0.8A DC	V _F	1.1							V
Maximum DC Reverse Current @T _J =25°C	I _R	5.0							μA
at Rated DC Bolcking Voltage @T _J =125°C		500							
Typical Junction Capacitance Per Element (Note2)	C _J	15							pF
Typical Thermal Resistance (Note3)	R _{θJC}	75							°C/W
Operating Temperature Range	T _J	-55 to +150							°C
Storage Temperature Range	T _{STG}	-55 to +150							°C

3. Thermal resistance junction to case.

RATINGS AND CHARACTERISTIC CURVES MB05M-G thru MB10M-G

FIG.1-FORWARD CURRENT DERATING CURVE

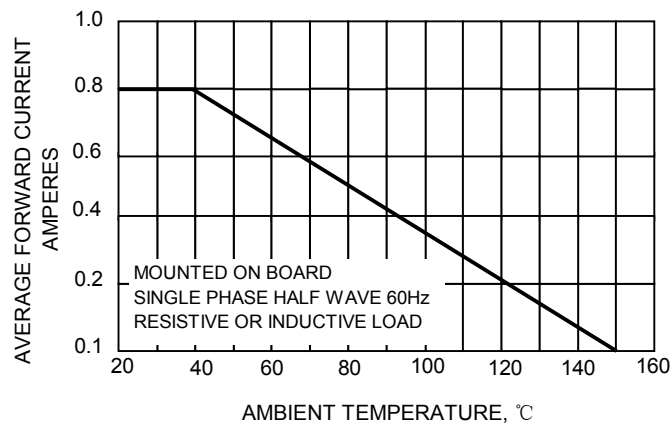


FIG.2-MAXIMUM NON-REPETITIVE SURGE CURRENT

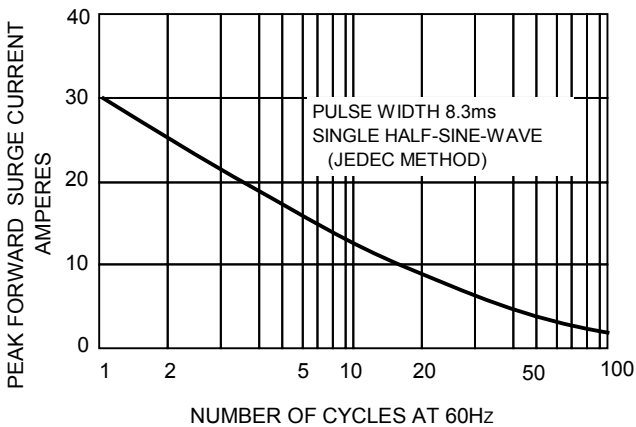


FIG.3-TYPICAL REVERSE CHARACTERISTICS

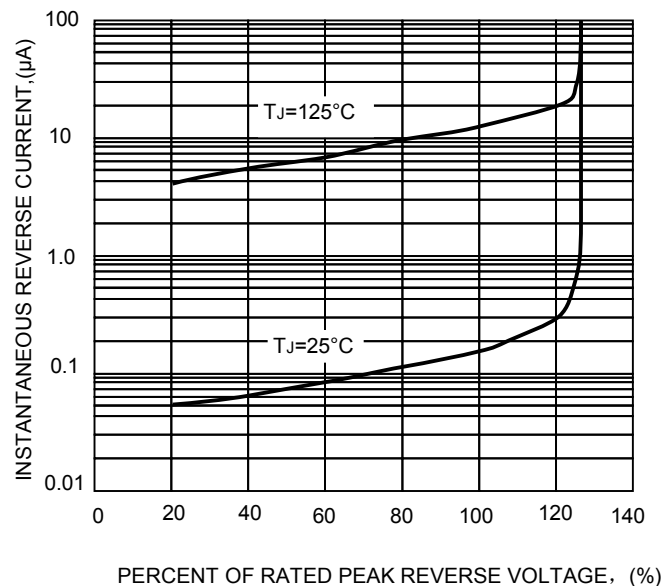


FIG.4-TYPICAL FORWARD CHARACTERISTICS

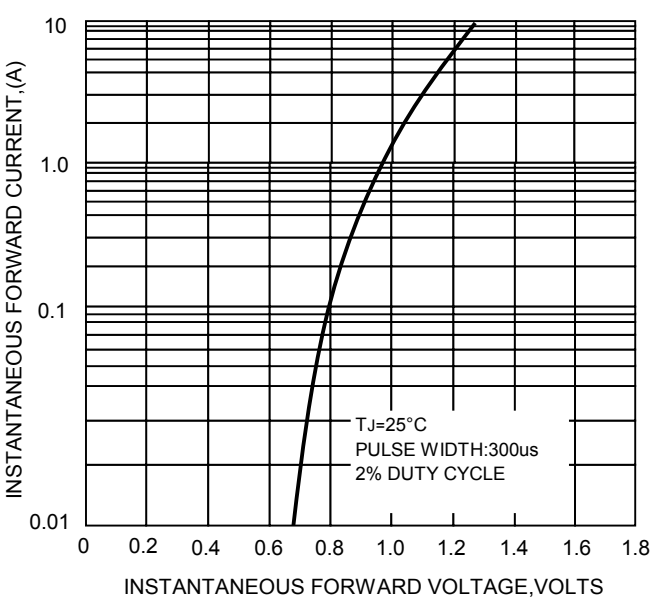


FIG.5-TYPICAL JUNCTION CAPACITANCE

